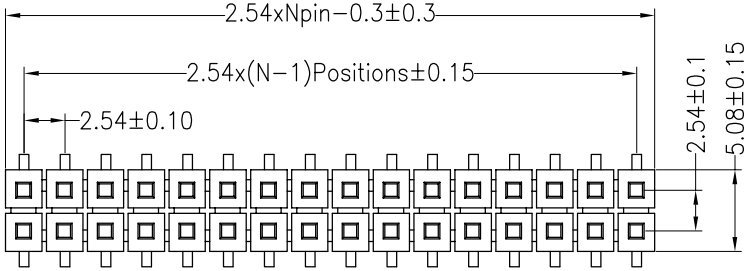
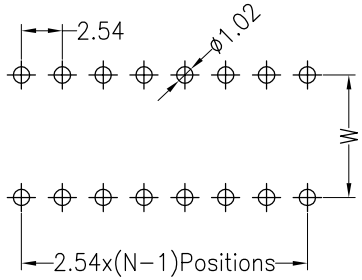
HSF RoHS

SPECIFICATIONS
Rated Current:3.0AMP
Contact Resistance:20mΩ Max
Withstand Voltage:1000V AC/DC
Insulation Resistance:1000MΩ Min
Operation Temperature:−40°c to +105°c

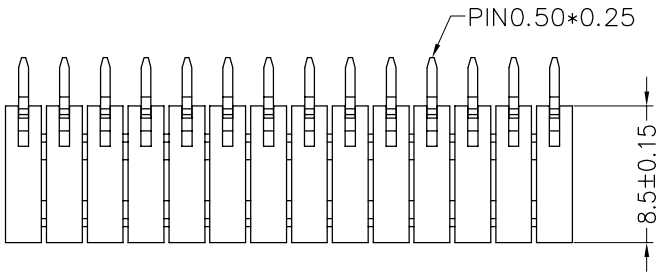
Contact Material:Brass
Contact Plating:Au or Sn Over Ni
Insulator Material:Polyester(UL94V−0)
Standard: PA46
Max.Processing Temp: 230°C for 30−60 seconds
(260°C for 10 seconds)

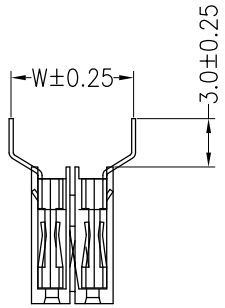
Recommended P.C.B Layout(Top Side)
(PCB BOARD TOLERANCE±0.05)





Dimension antitheses list	
ITEM	W
Standard	01=7.62
Standard	02=6.50





Ordering Information

2285 E2 XX X N XX SU X 0X

- XX: No.of Pins 2*2~2*40
- X: Insulator Material Option
  - C=PA6T
  - D=PA46
  - E=PA9T
  - F=LCP
- XX: Contact Plating
  - G1:Gold Flash
  - G3:2U" Gold
  - G4:3U" Gold
  - G5:5U" Gold
  - G6:10U" Gold
  - G7:15U" Gold
  - S0:Gold Flash/Tin
  - SN:Tin
- X: Packing
  - 0=PE Bag
  - A=Tray
  - T=Tube
  - P=Tube+Cap

REV	DATE	MODIFICATION DESCRIPTION	CHANGE
A0	2021.06.23	NEW DRAWING	

OPERATION		DRAW	Liu Miao	21.06.23	SCALE	FIT
X.X	±0.30				UNIT	mm
X.XX	±0.20	CHECK			SIZE	A4
X.XXX	±0.10				SHEET	1/1
Angle	±3°	APPROVE			PROJ.	
DIM	TOL					

WFD CONN 深圳市旺富达电子有限公司
SHEN ZHEN WFD ELECTRONICS CO., LTD

PART NO.	2285E2XXXNXXSUX0X
TITLE:	2.54PF 2xNPin H8.5mm easy−breaking